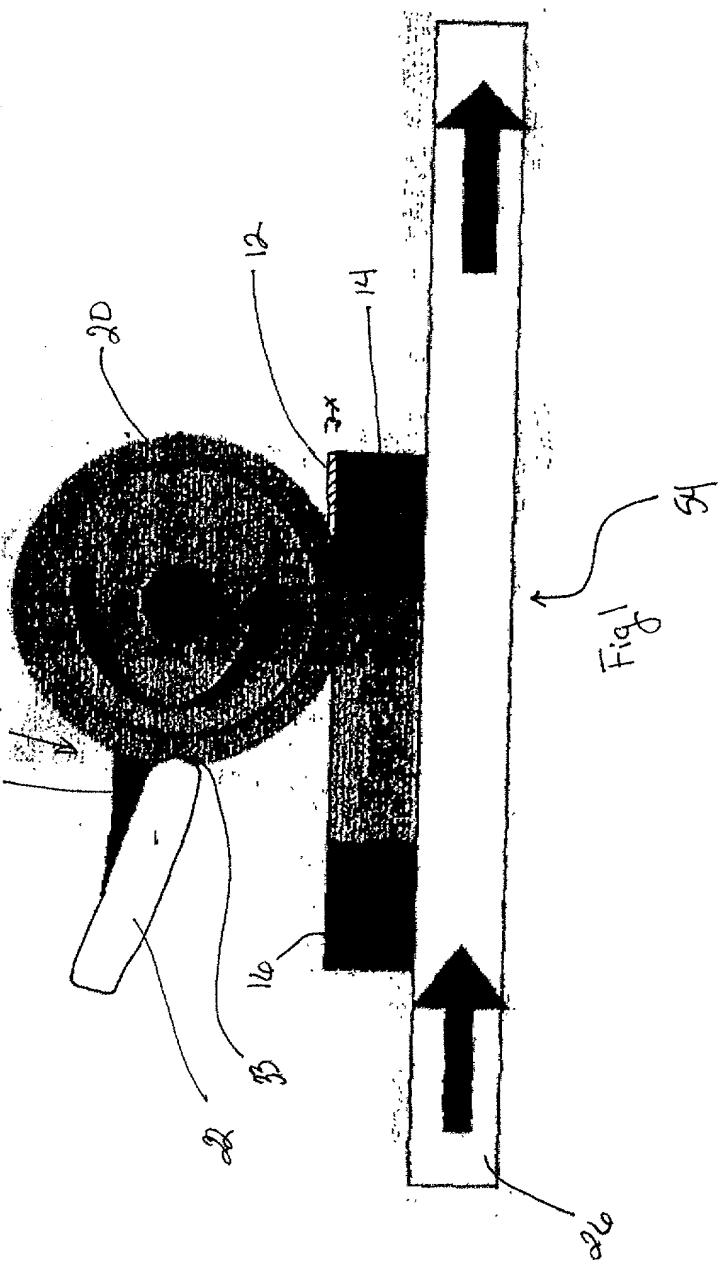


FIG. 1

FIG. 2





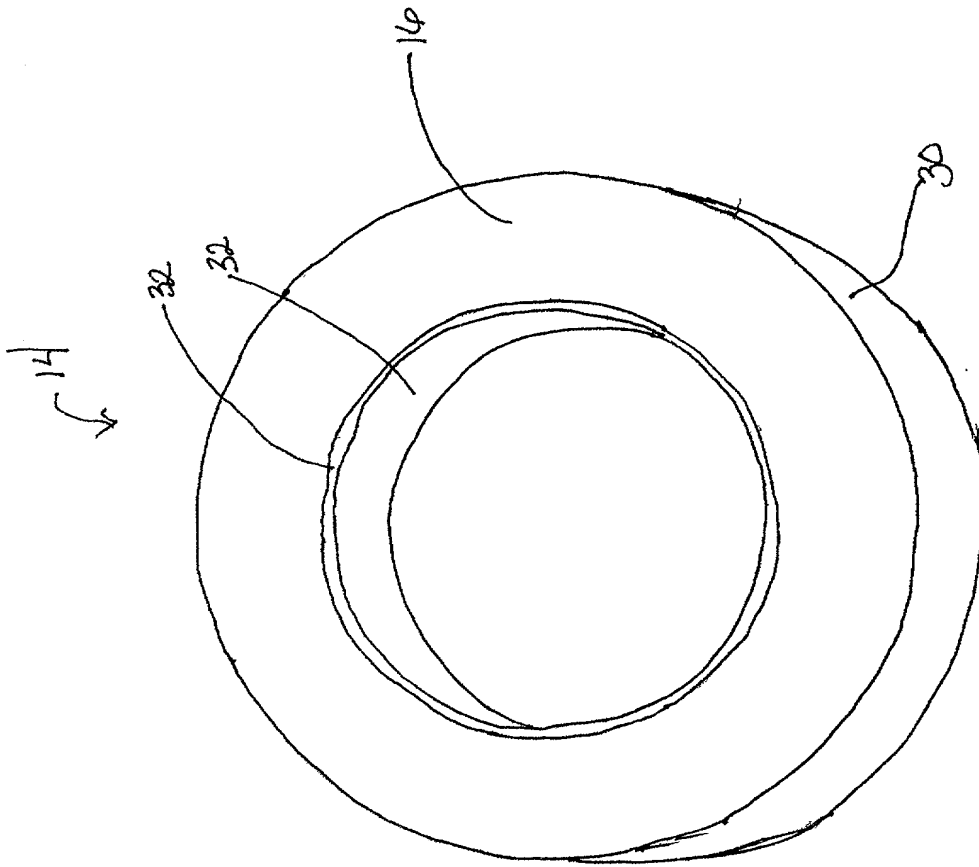


Fig. 4

40

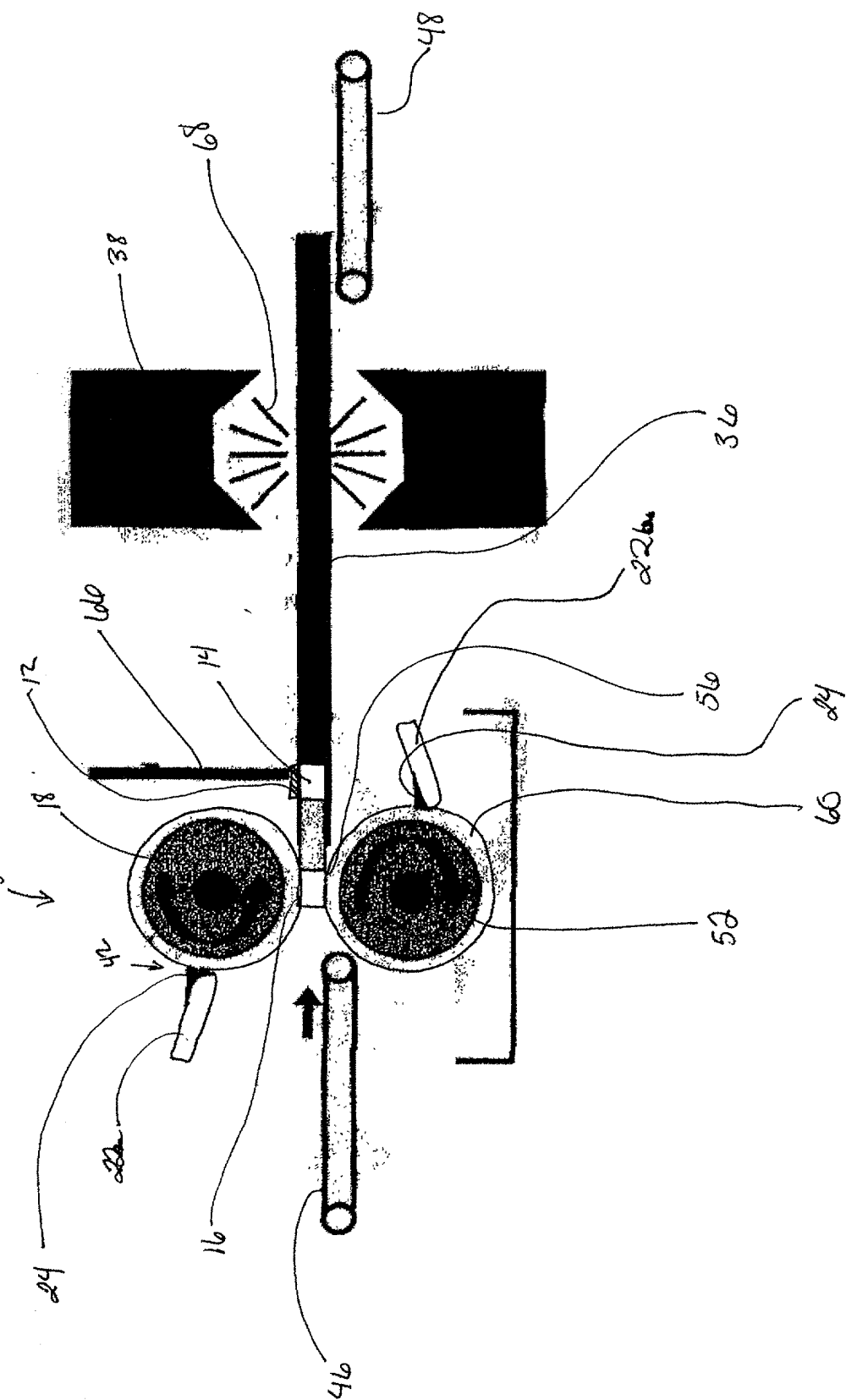


Fig 5

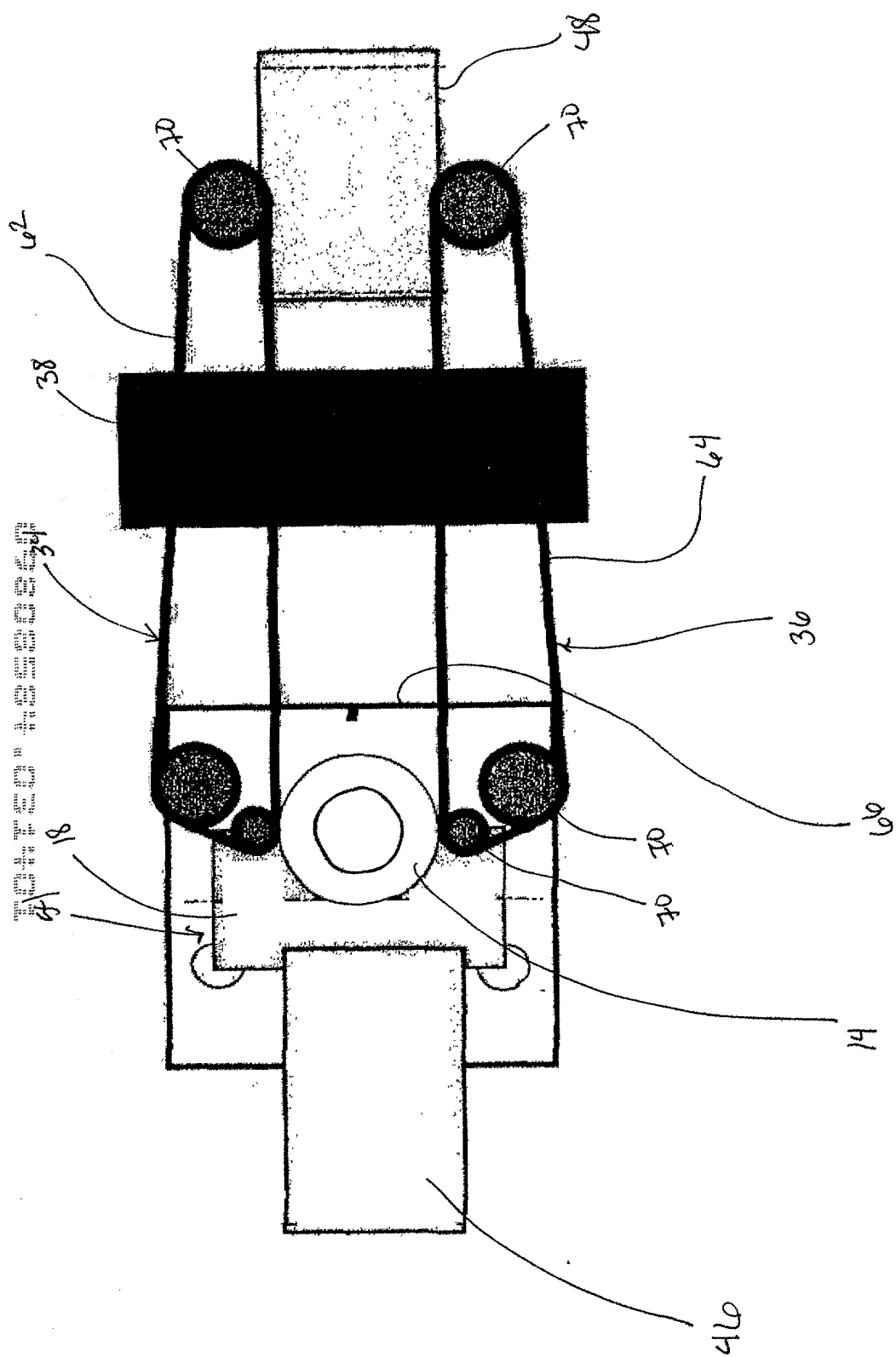


Fig. 6

2014-08-22

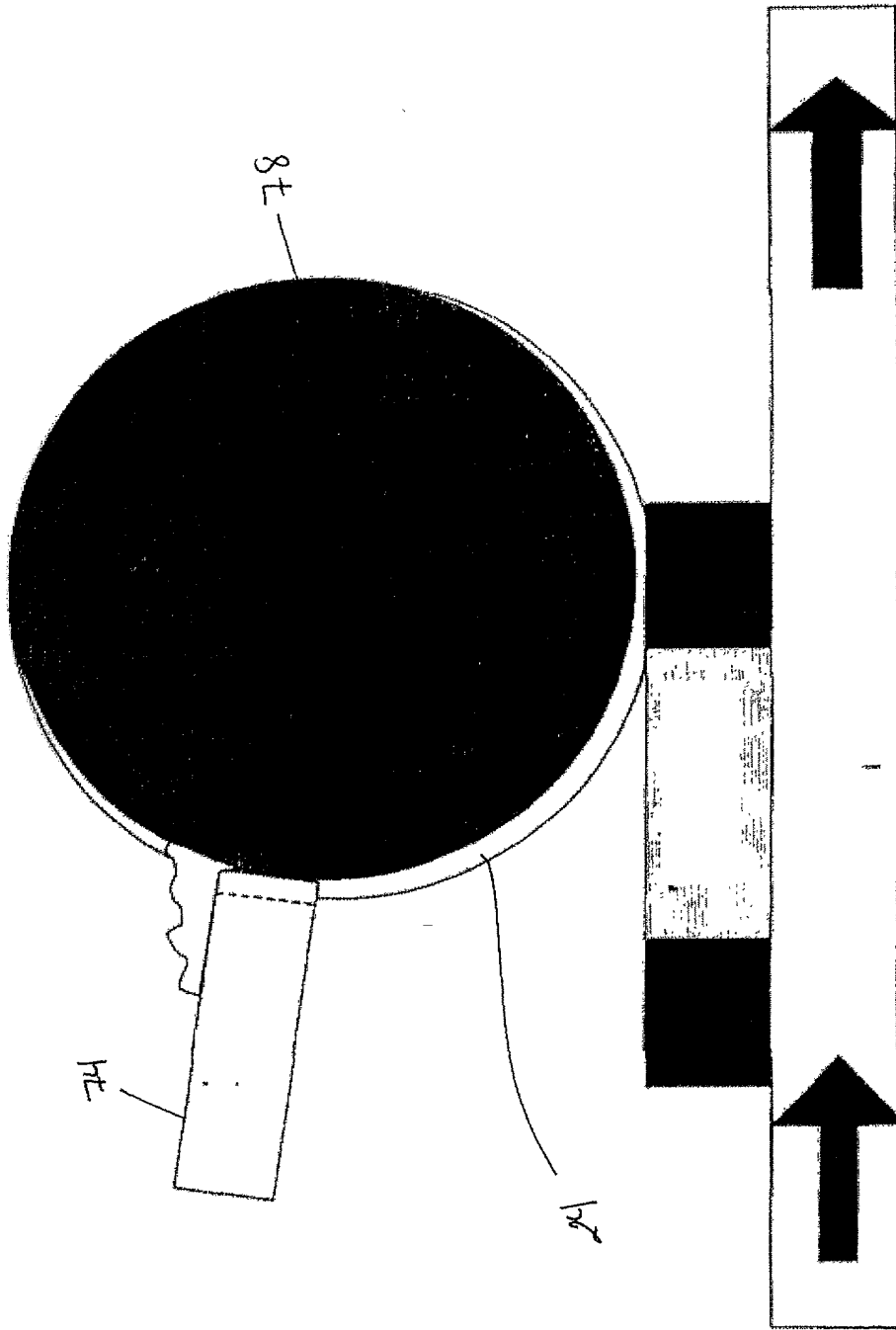


Fig. 7

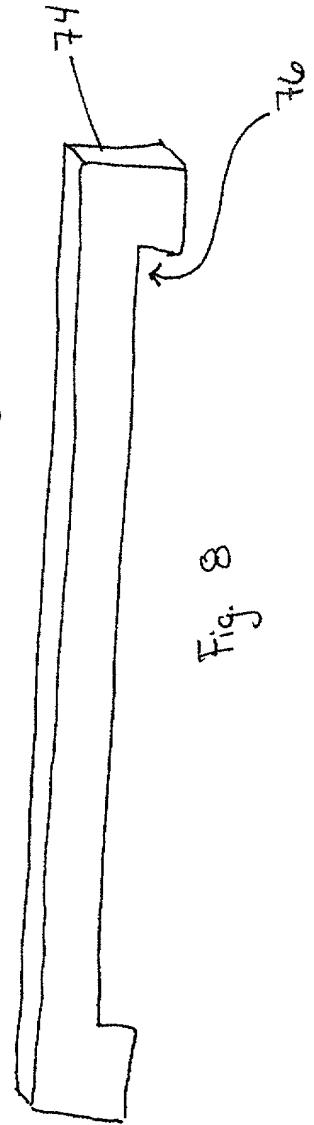
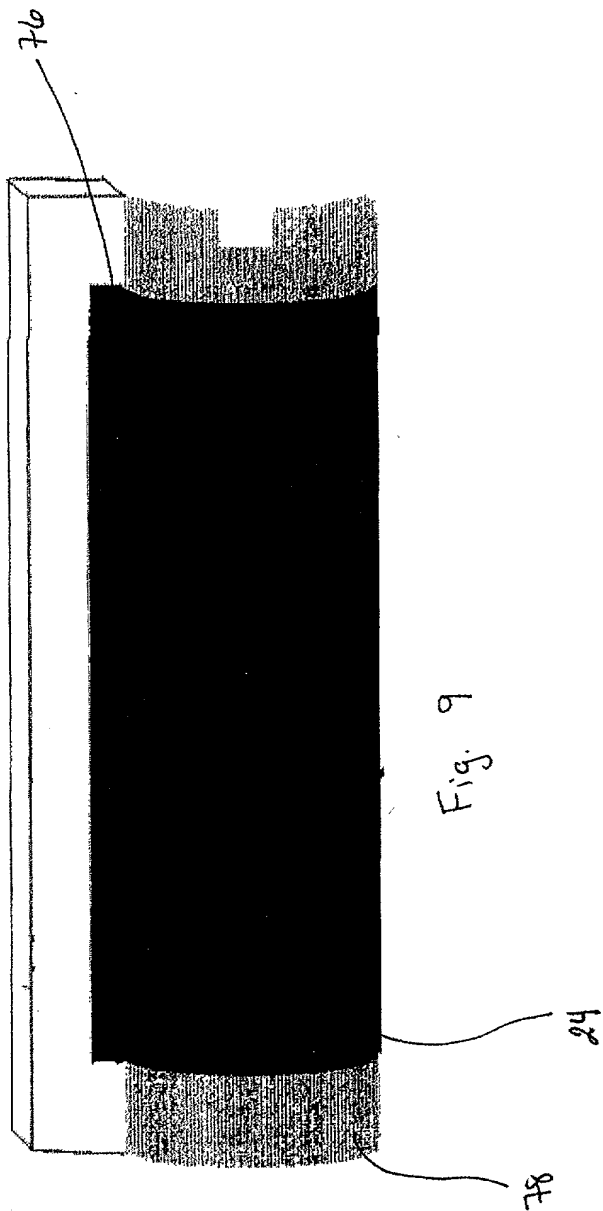


Fig. 8

FIG. 9 is a cross-sectional view of a device 24, showing a substrate 78, a layer 76, and a layer 74. The layer 76 is a thin layer of material, and the layer 74 is a thicker layer of material. The device 24 is shown in a cross-sectional view, with the substrate 78 at the bottom, the layer 76 in the middle, and the layer 74 on top. The layer 76 is a thin layer of material, and the layer 74 is a thicker layer of material.



80

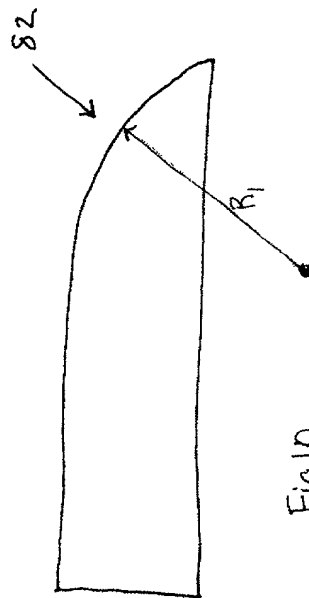


Fig. 10

SCANNED, #4

86

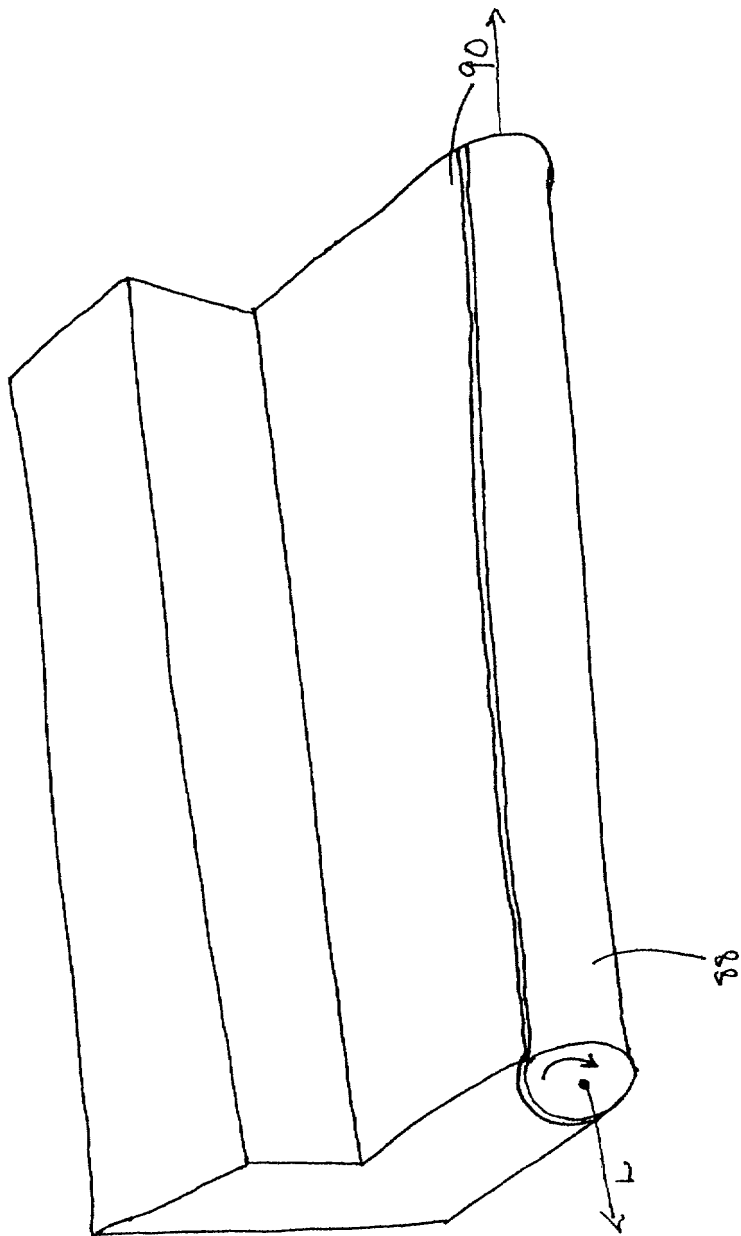


Fig. 11



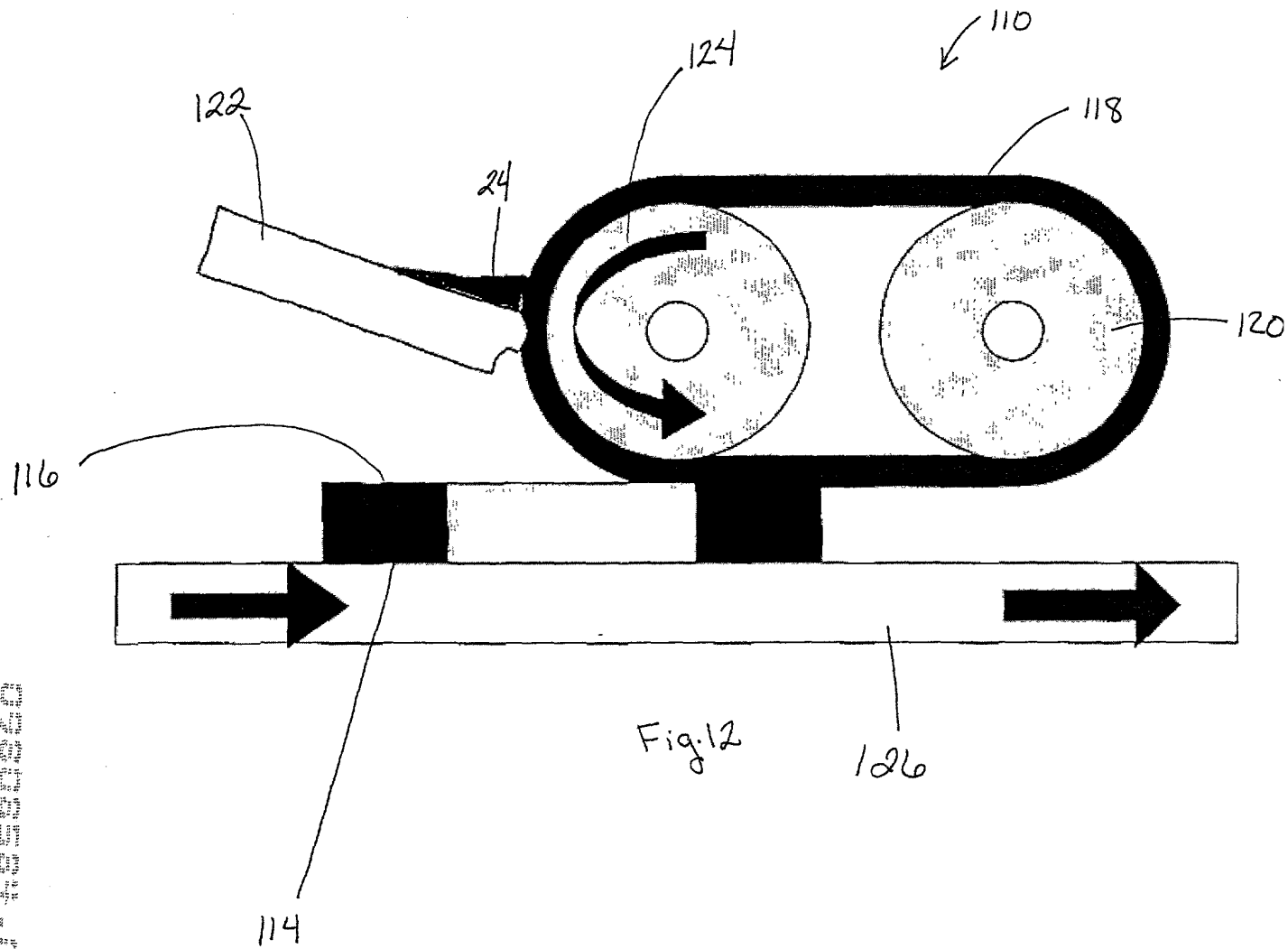


Fig. 12